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(12)

United States Design Patent

Chen et al.

(10)

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(45)

Date of Patent:

** Dec. 16, 2025

- (54) MICROPHONE MOUNT
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- (73) Assignee: Hewlett-Packard Development Company, L.P., Spring, TX (US)
- (**) Term: 15 Years
- (21) Appl. No.: 30/008,499
- (22) Filed: Jun. 16, 2025

Related U.S. Application Data

- (63) Continuation of application No. 29/913,246, filed on Sep. 28, 2023, now Pat. No. Des. 1,083,885.
- (51) LOC (15) Cl. 14-01
- (52) U.S. Cl. D14/229
- (58) Field of Classification Search
- USPC D14/229, 225, 228, 432; D8/396, 354; D17/99; D6/682; 381/361, 368; 84/419, 84/421; 248/176.1, 610

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Primary Examiner — Paula Allen Greene
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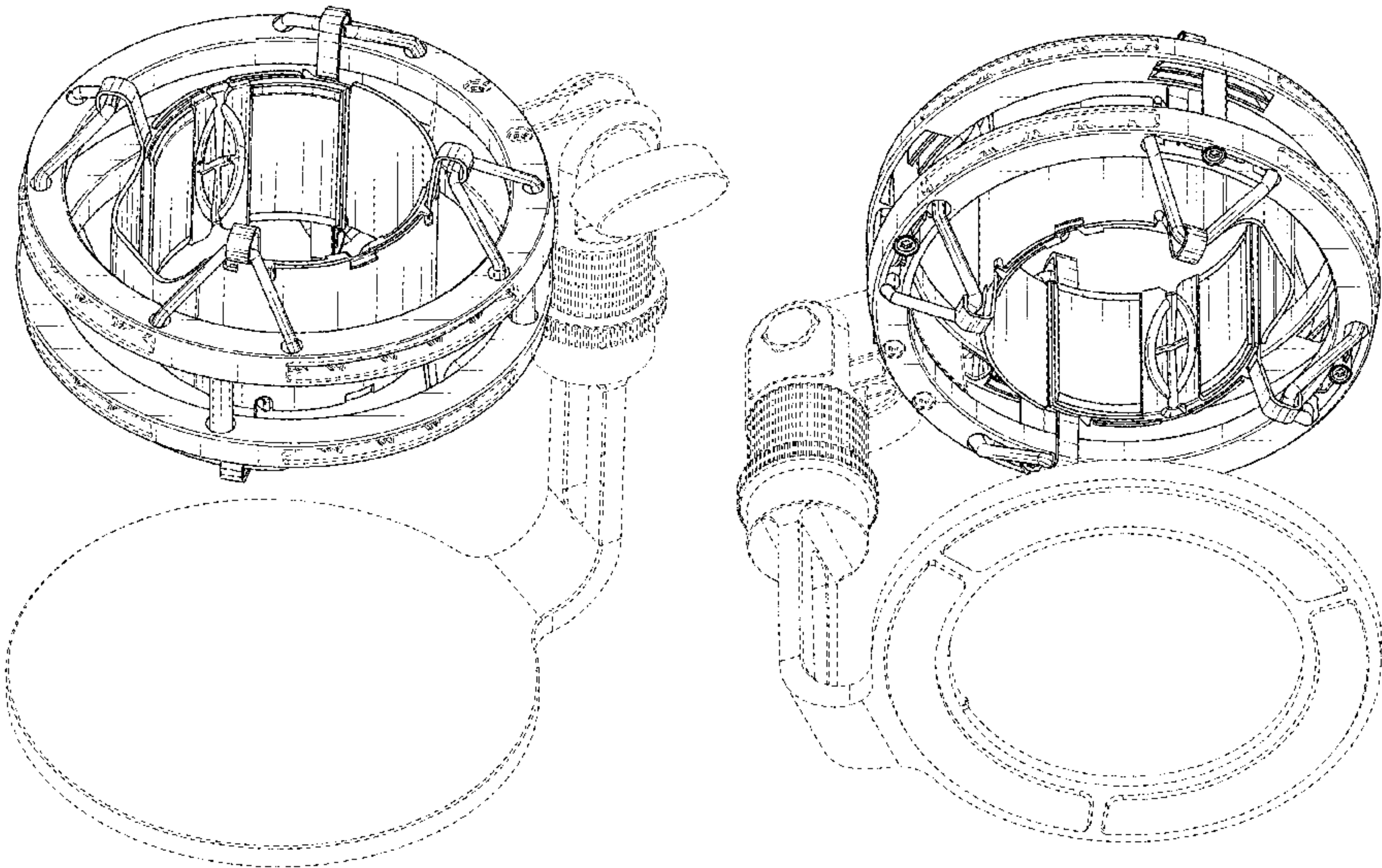
(57) CLAIM

The ornamental design for a microphone mount, as shown and described.

DESCRIPTION

FIG. 1 is an isometric view of a top, front, and left side of an ornamental design for a microphone mount with a microphone attached thereto;
FIG. 2 is a top plan view of the microphone mount of FIG. 1;
FIG. 3 is a bottom plan view of the microphone mount of FIG. 1;
FIG. 4 is a right side elevational view of the microphone mount of FIG. 1;
FIG. 5 is a left side elevational view of the microphone mount of FIG. 1;
FIG. 6 is a front elevational view of the microphone mount of FIG. 1;
FIG. 7 is a rear elevational view of the microphone mount of FIG. 1;
FIG. 8 is an isometric view of a top, front, and right side of the microphone mount of FIG. 1 with a microphone removed therefrom;
FIG. 9 is an isometric view of a bottom, front, and left side of the microphone mount of FIG. 1 with a microphone removed therefrom;
FIG. 10 is a bottom plan view of the microphone mount of FIG. 1 with the base removed therefrom; and,
FIG. 11 is an isometric view of the microphone mount of FIG. 1 configured to receive a microphone boom about an adaptor thereof.
The dash-dash-dash lines illustrate portions of the microphone mount that form no part of the claimed design. The dash-dot-dash broken lines are included for the purpose of illustrating boundary lines and form no part of the claimed design.

1 Claim, 9 Drawing Sheets



(58) **Field of Classification Search**
CPC . H04R 25/00; H04R 1/08; H04R 9/04; F16M
11/10; F16M 13/00; F16M 11/04
See application file for complete search history.

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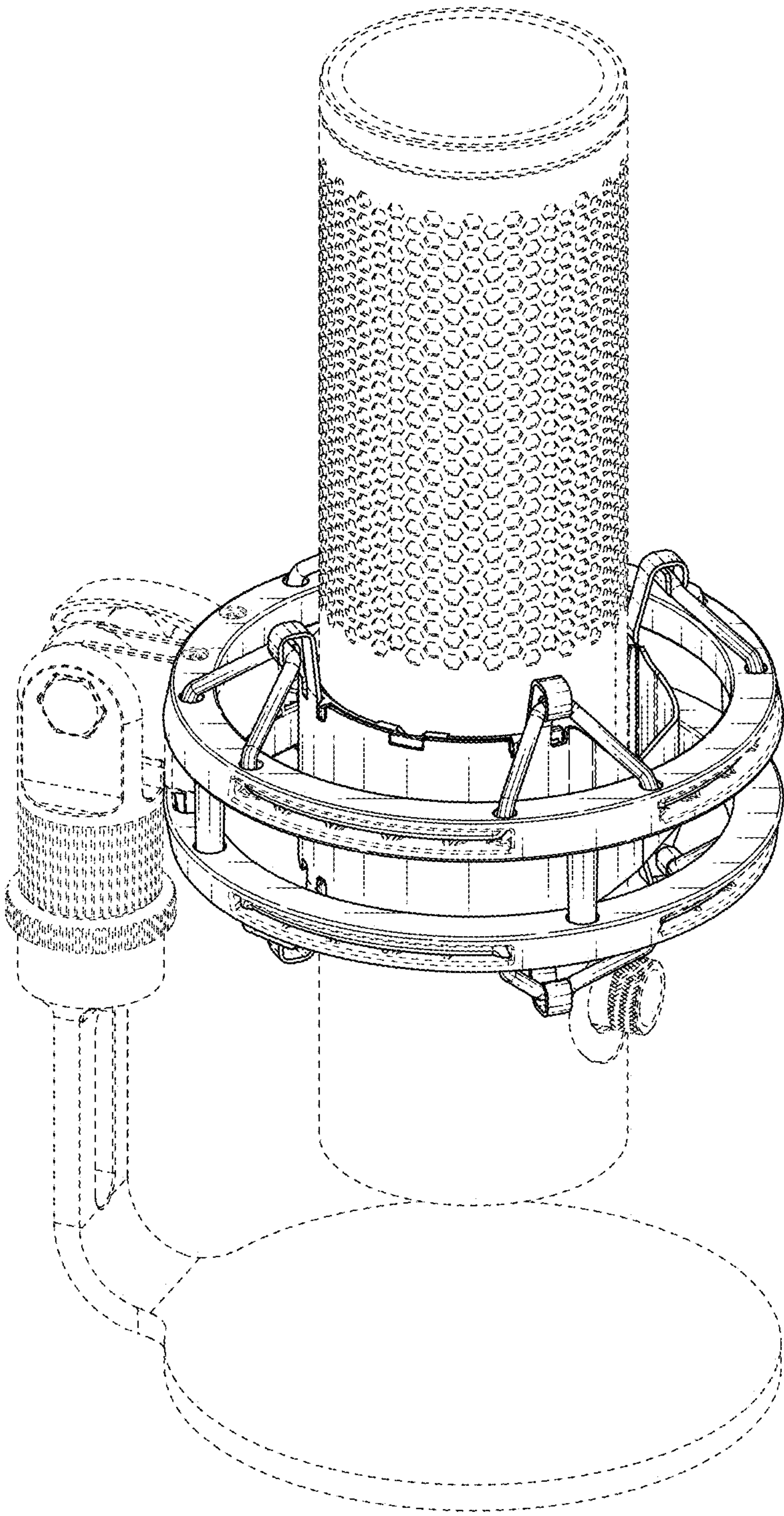


FIG. 1

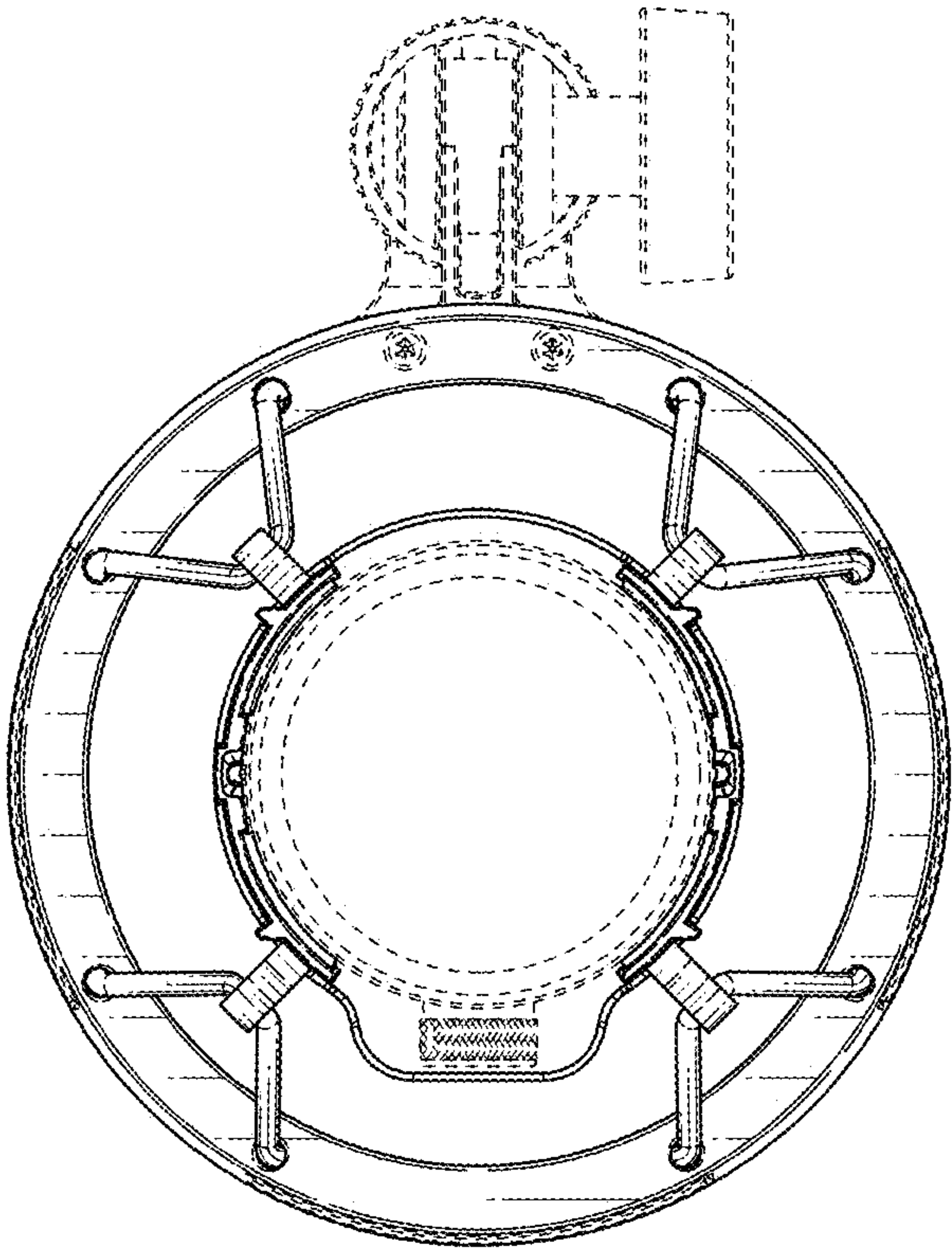


FIG. 2

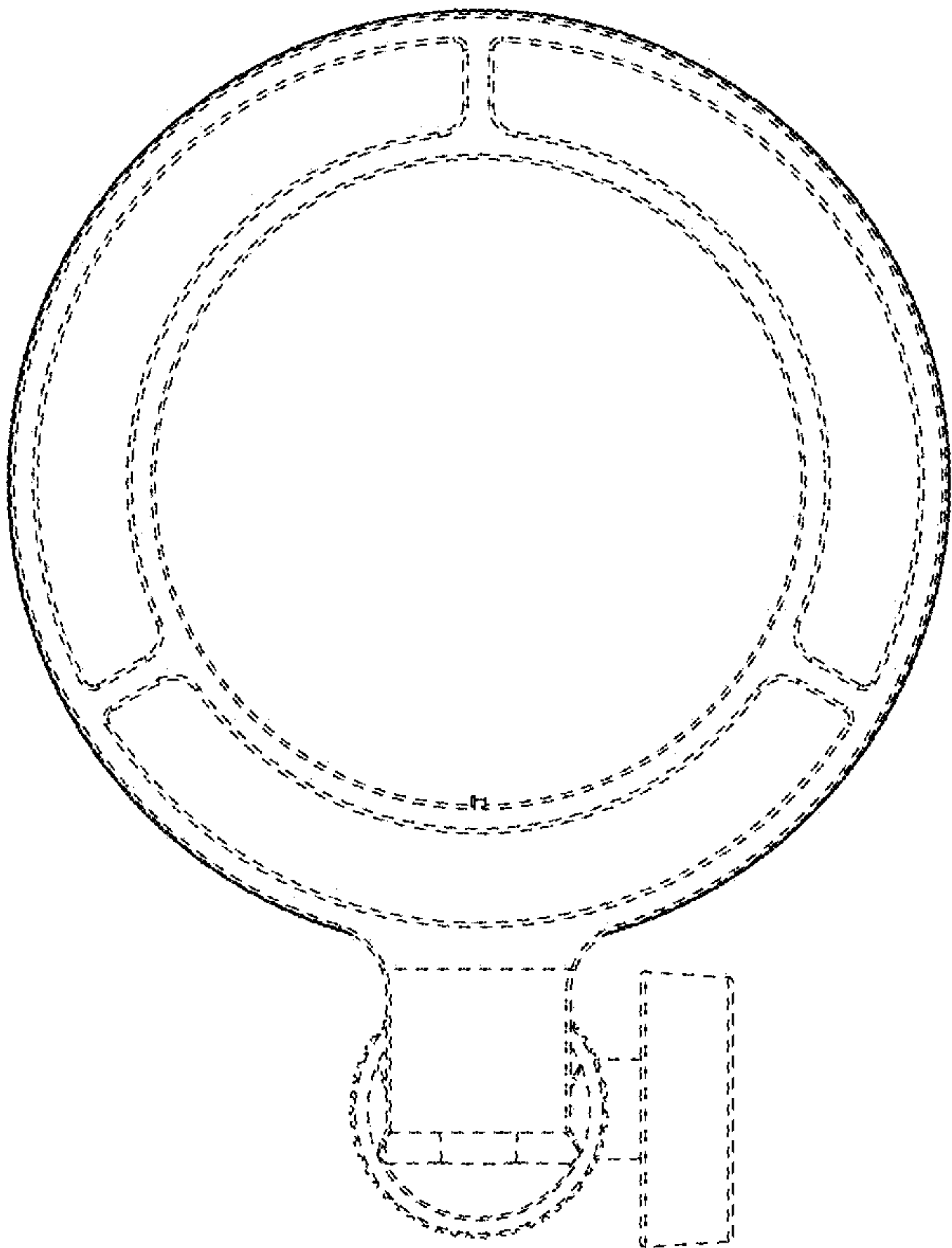


FIG. 3

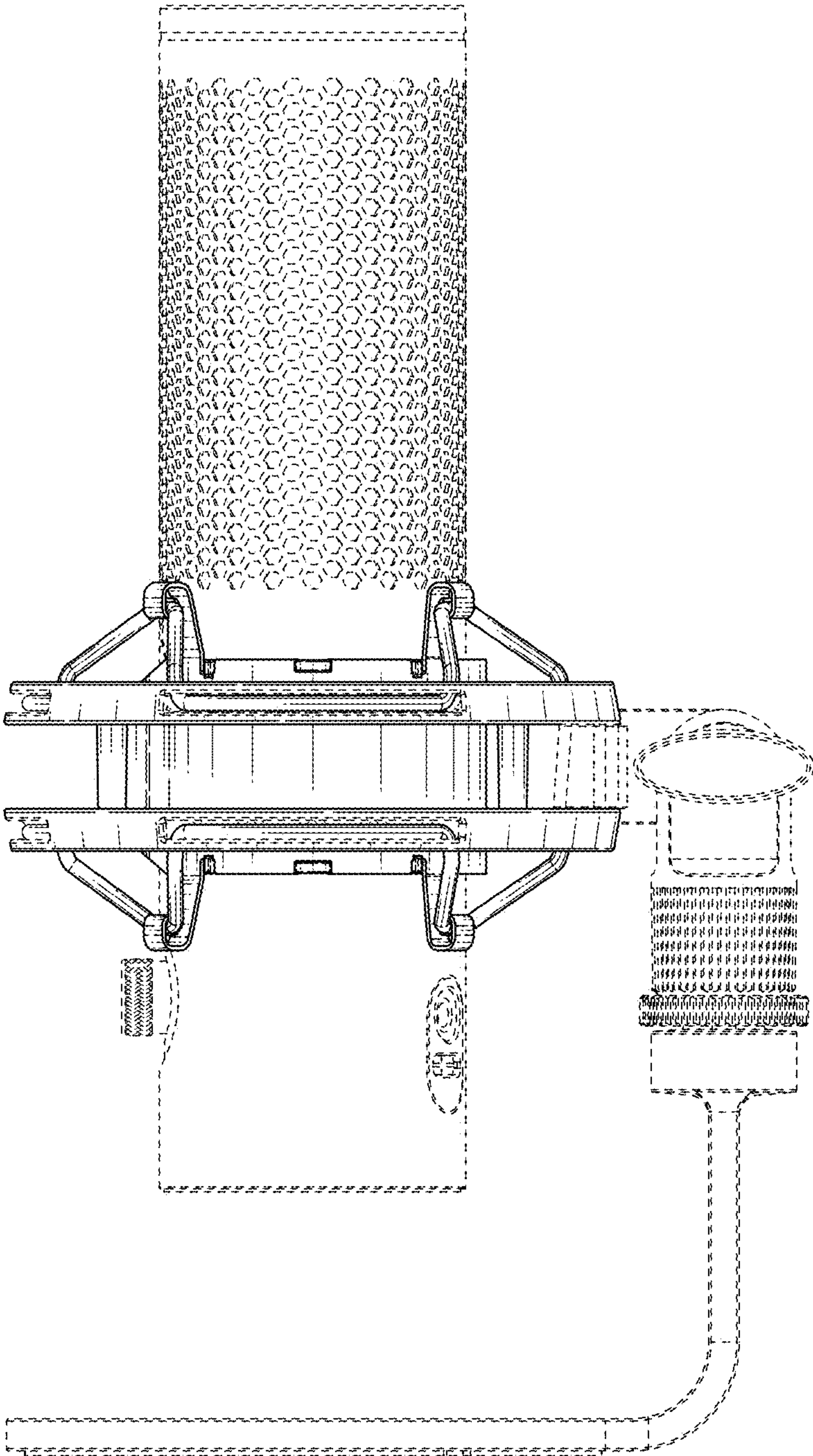


FIG. 4

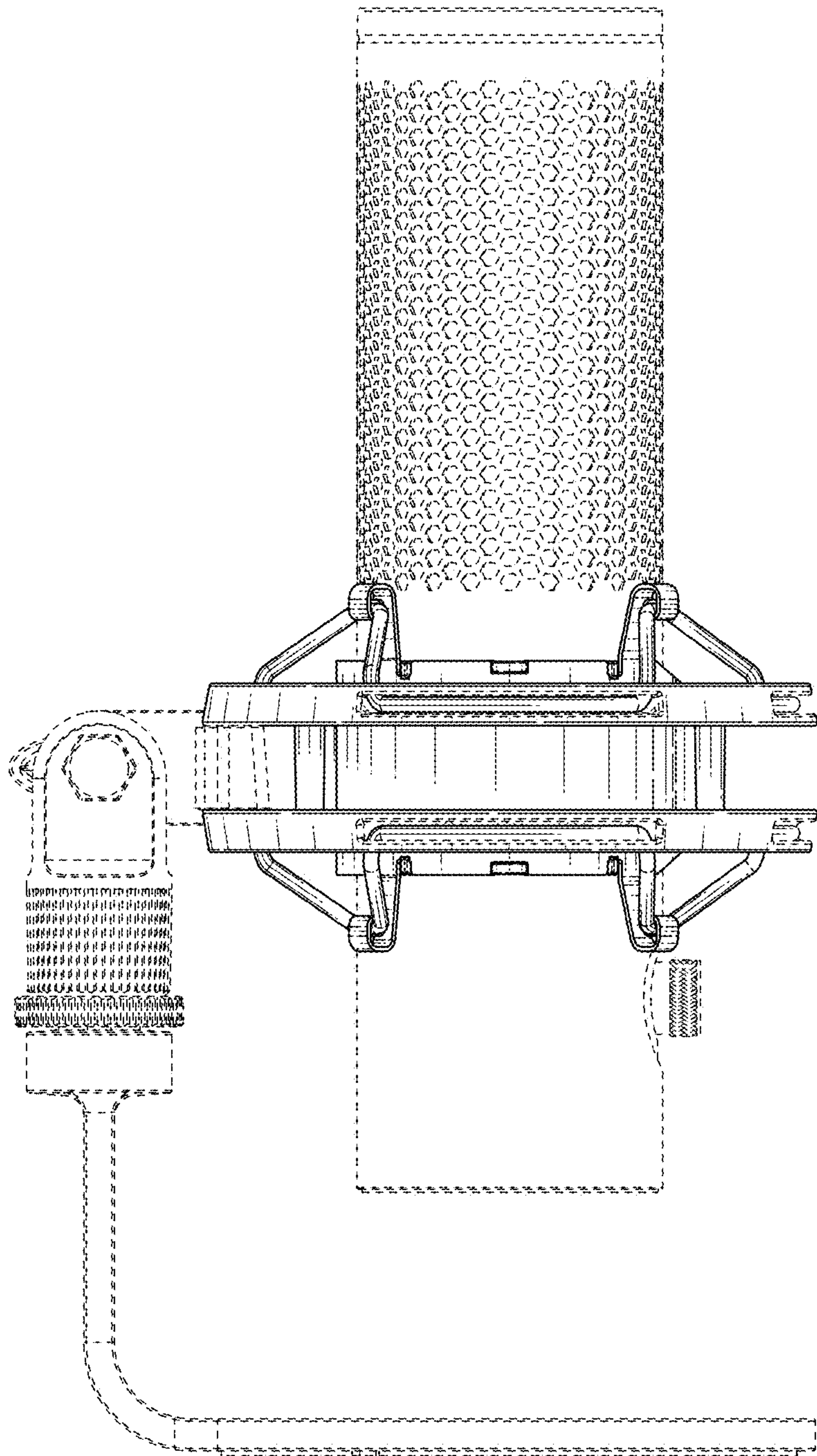


FIG. 5

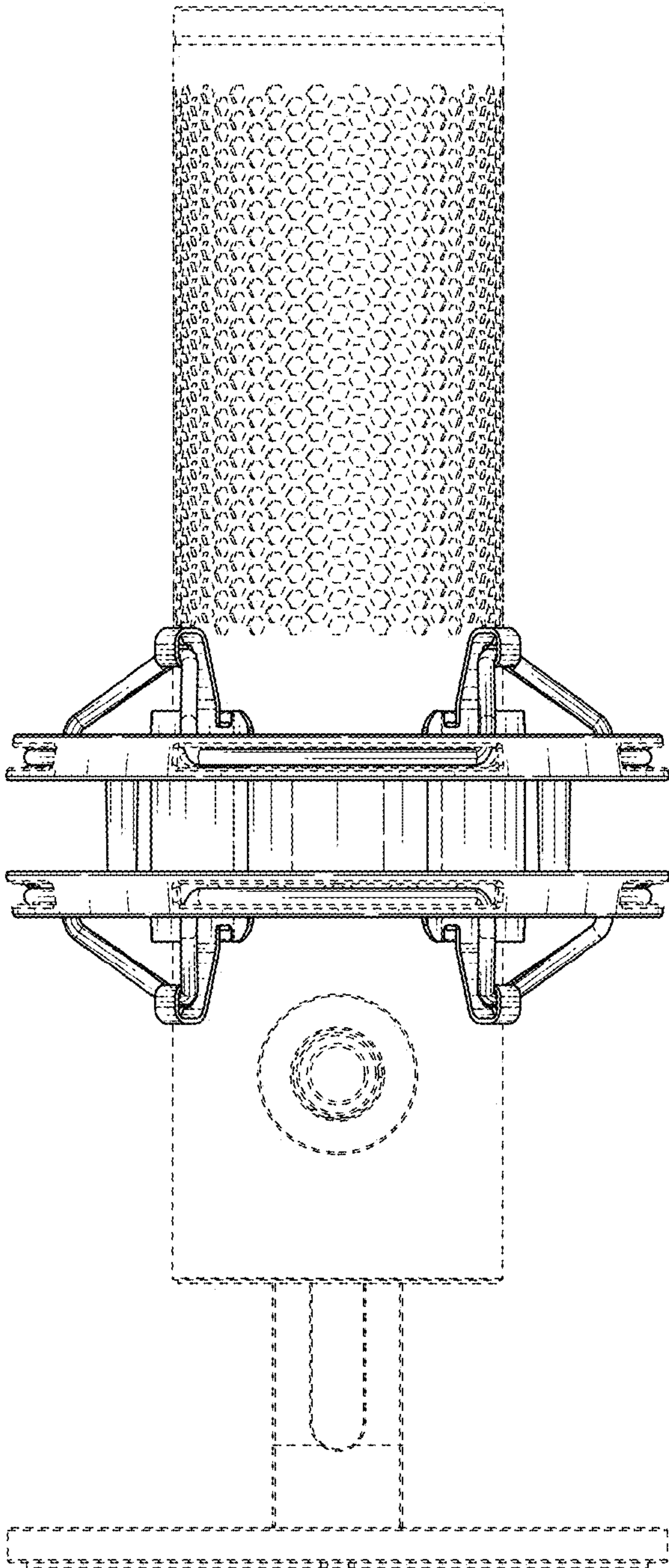


FIG. 6

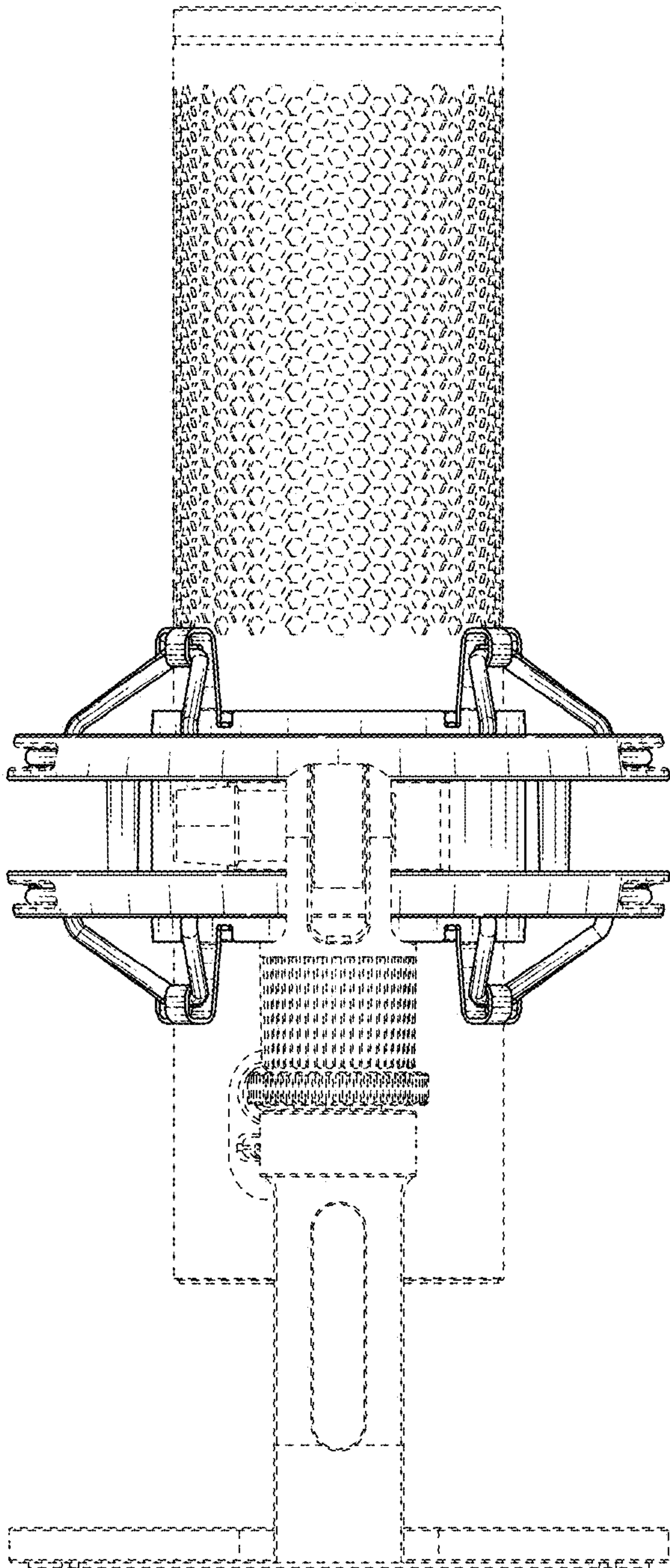


FIG. 7

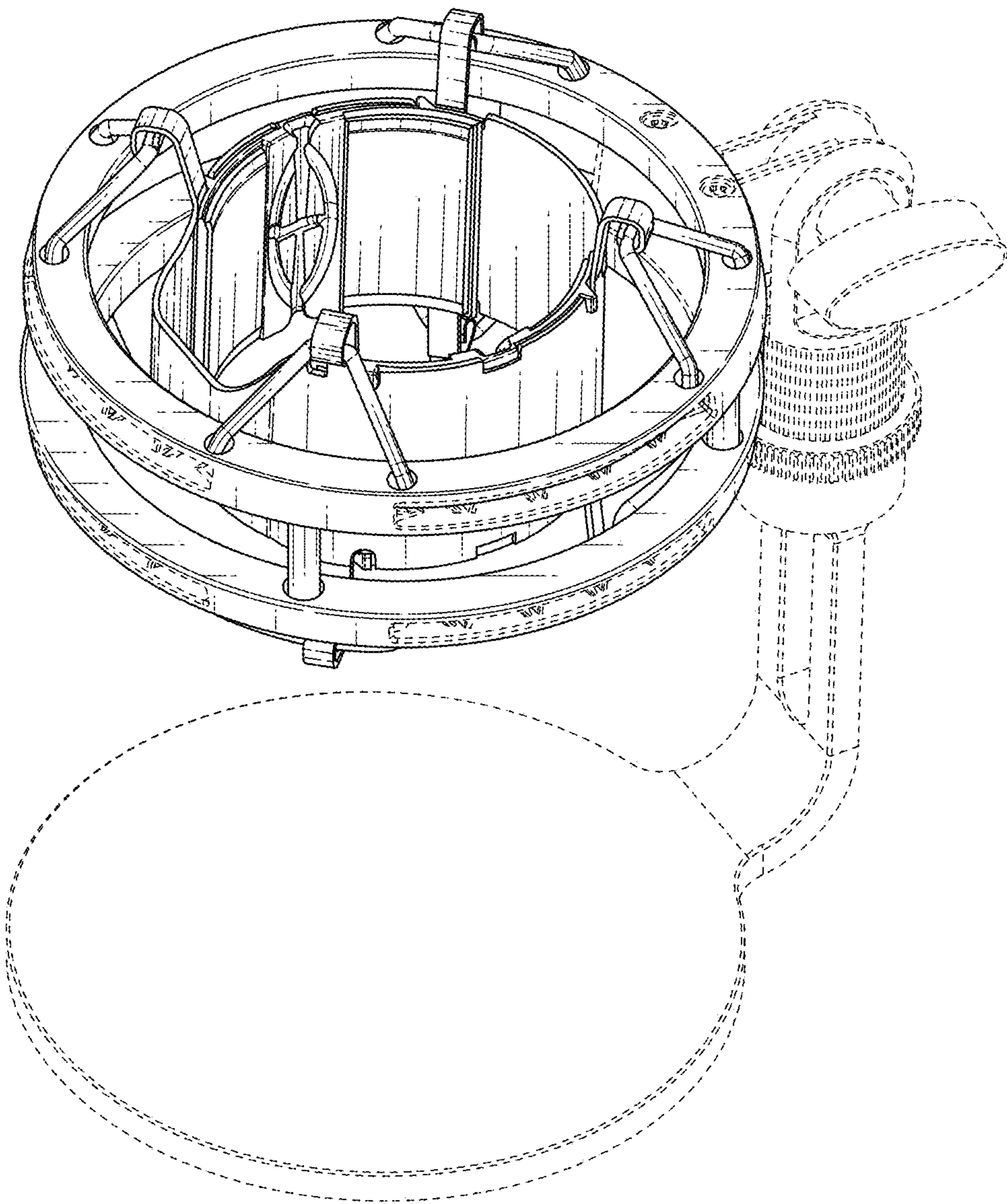


FIG. 8

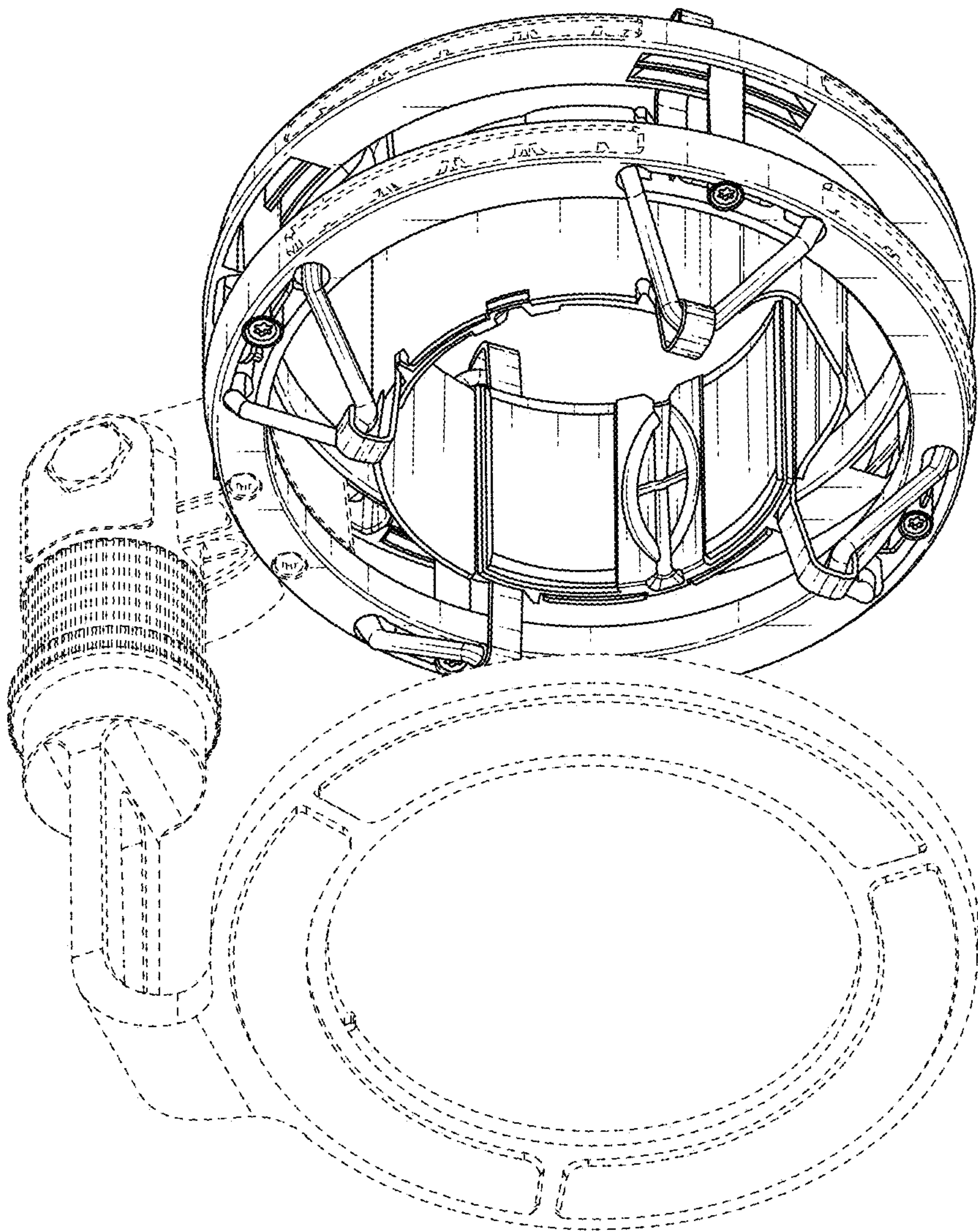


FIG. 9

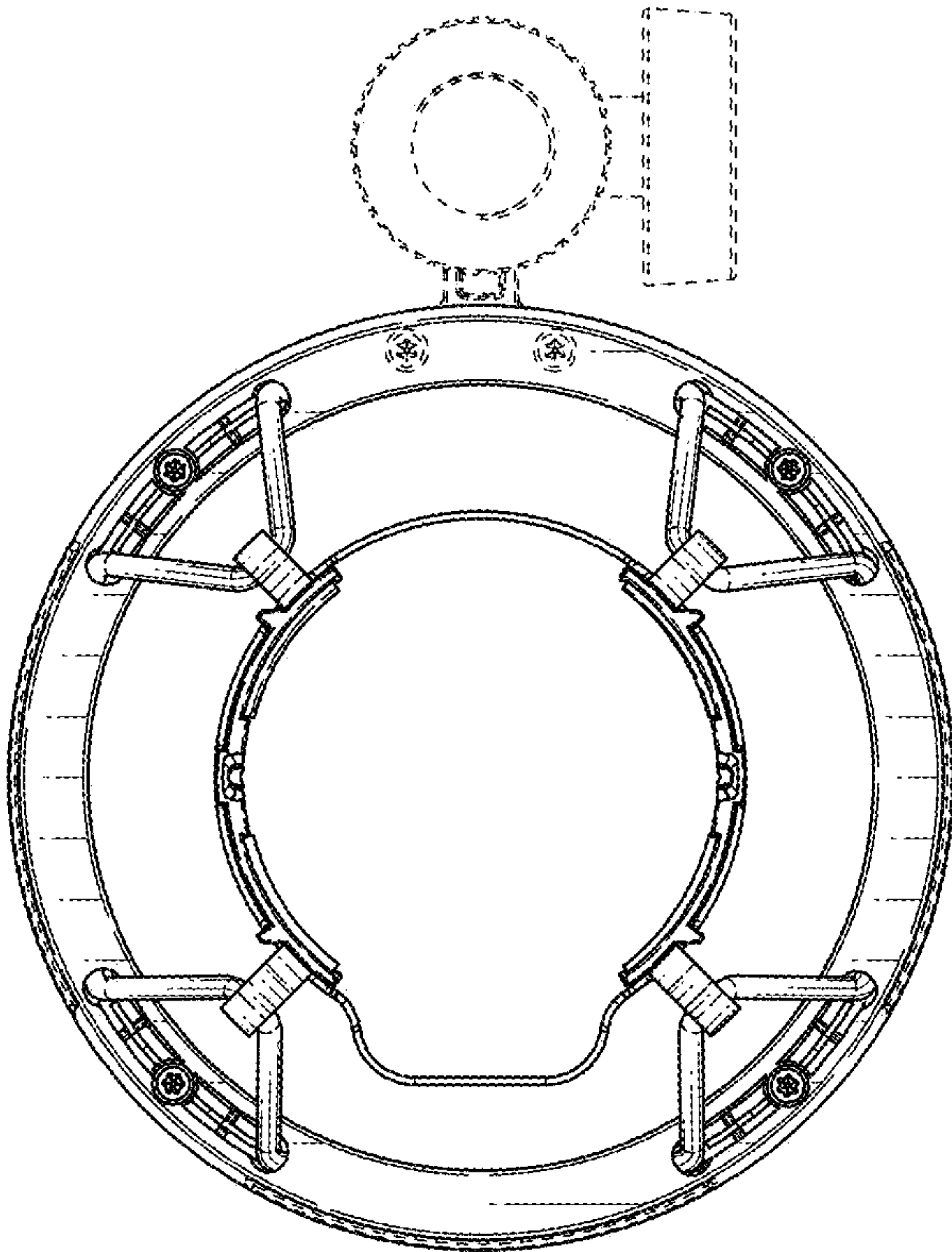


FIG. 10

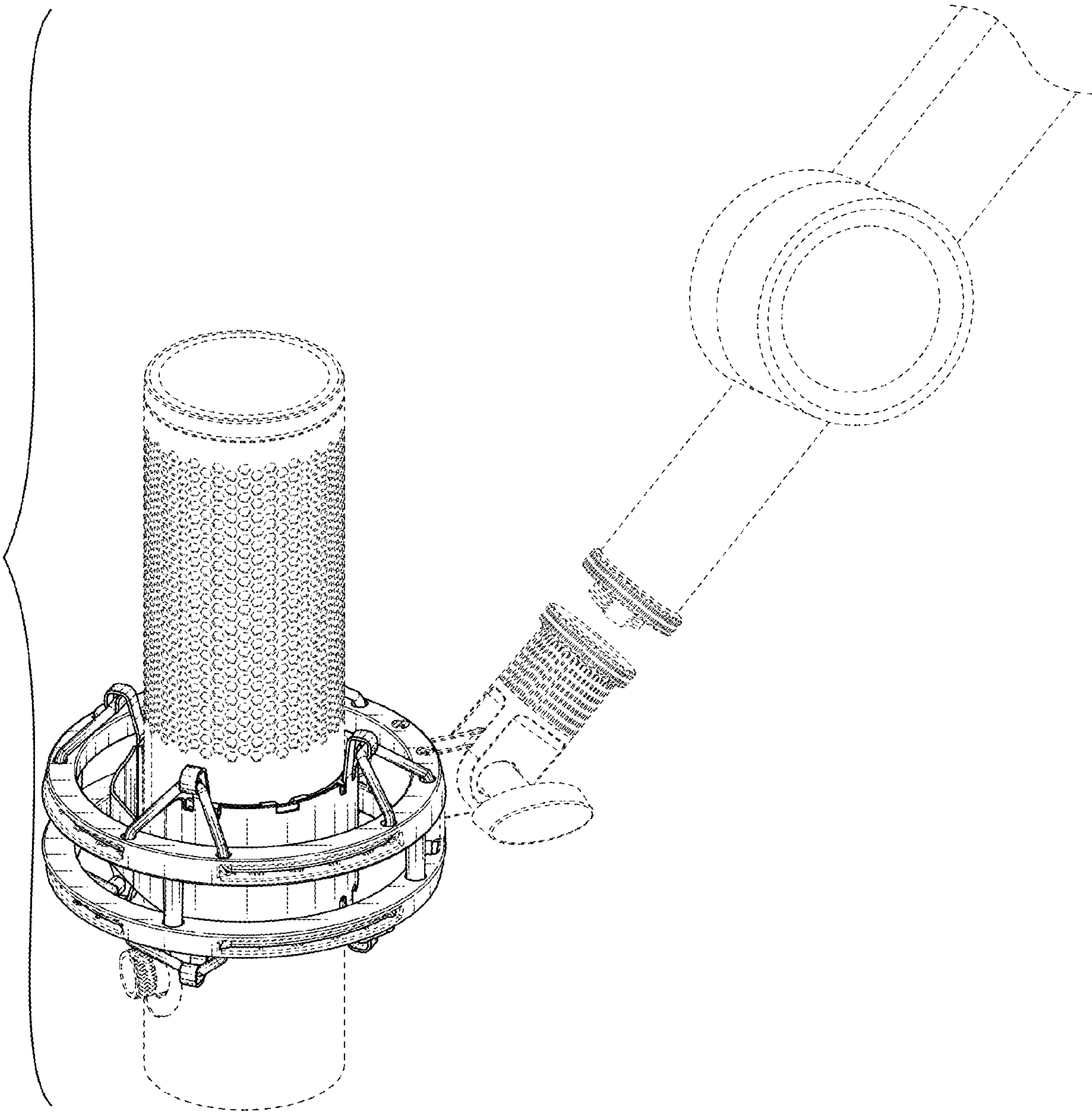


FIG. 11